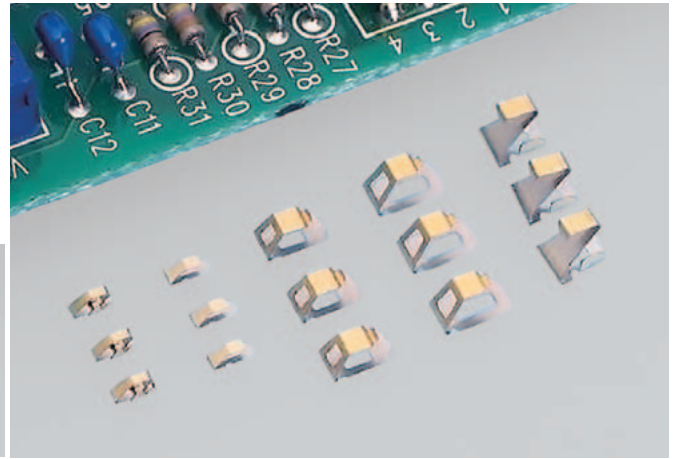
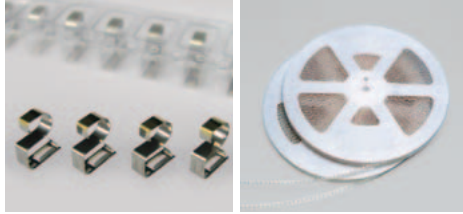


概要と特長

Product Outline and Features

- ▶ 豊富なサイズバリエーションを取り揃えております。
- ▶ エンボスキャリアテープに収納され、自動マウントが可能です。
- There are extensive size variation.
- Since the fingers are on embossed carrier tape, they can be used in an automatic mounting line.



仕様

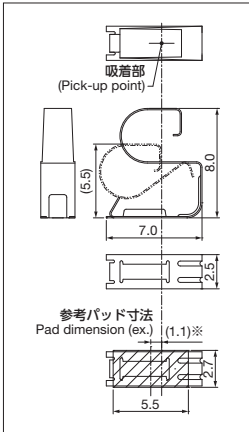
Specifications

形番 Part No.	初期高さ (mm) Initial Height	幅 (mm) Width	長さ (mm) Length	材質 Materials (下記 Following)	1巻数量(リール径) Qty. of Reel (Reel Dia.)	推奨使用圧縮範囲 (mm) Recommended use range compression
E01J8025P	8.0	2.5	7.0	①	1300 (φ 380)	5.5~7.2
E01J6022P	6.0	2.2	5.2	①	1800 (φ 380)	3.5~5.4
E01J4032Y	4.0	3.2	4.0	②	2000 (φ 330)	2.8~3.6
E01J3028Y	3.0	2.8	5.0	②	2500 (φ 330)	2.1~2.6
E01J3022Y	3.0	2.2	2.8	②	2500 (φ 330)	2.2~2.6
E01J2024Y	2.0	2.4	4.5	②	5000 (φ 330)	1.4~1.8
E01J1511Y	1.5	1.1	3.0	②	5000 (φ 330)	1.15~1.35
E01J1113Y	1.1	1.3	3.0	②	5000 (φ 330)	0.65~0.9

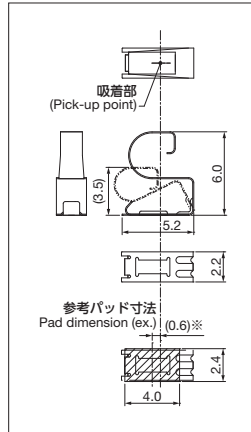
材質 Materials

- ① : バネ用リン青銅
Phosphor Bronze for spring
[全面 Ni / 部分Auめっき(接触面・はんだ面)]
[Ni (whole surface) / Au plating (contact and solder surfaces)]
- ② : チタン銅合金
Titanium Copper
[全面 Ni / 部分Auめっき(接触面・はんだ面)]
[Ni (whole surface) / Au plating (contact and solder surfaces)]

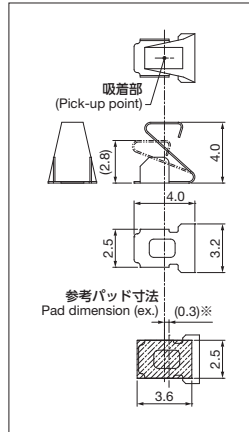
E01J8025P



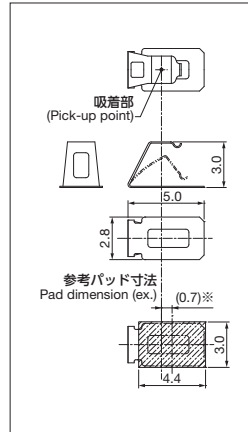
E01J6022P



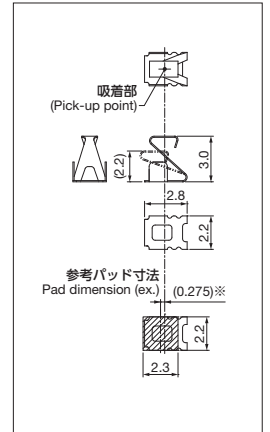
E01J4032Y



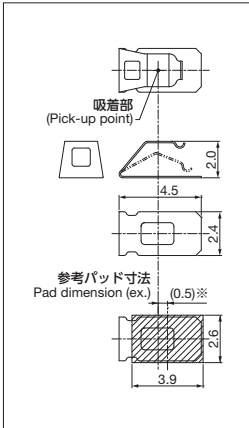
E01J3028Y



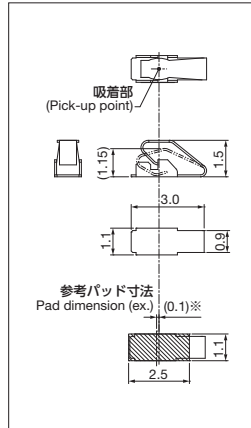
E01J3022Y



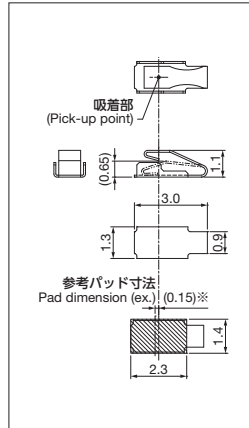
E01J2024Y



E01J1511Y



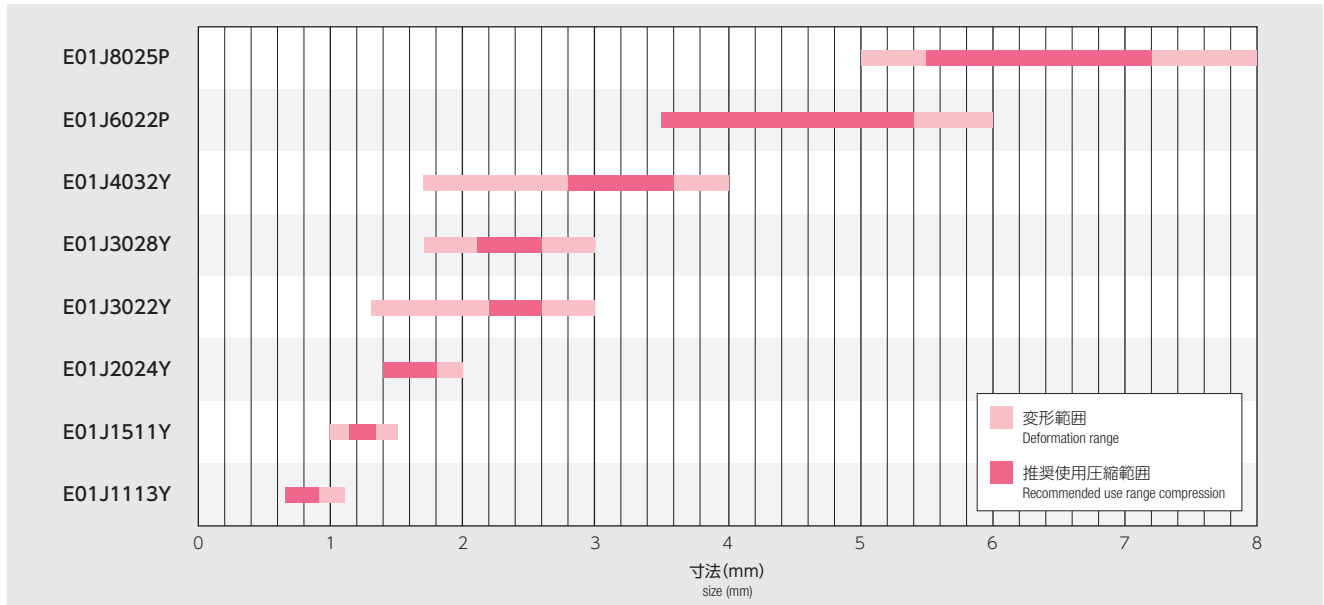
E01J1113Y



※パッド中心と吸着面中心のオフセット量。
※Distance between pad center and contact area center

推奨使用圧縮範囲

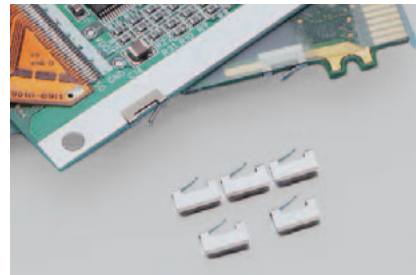
Recommended use range compression



概要と特長

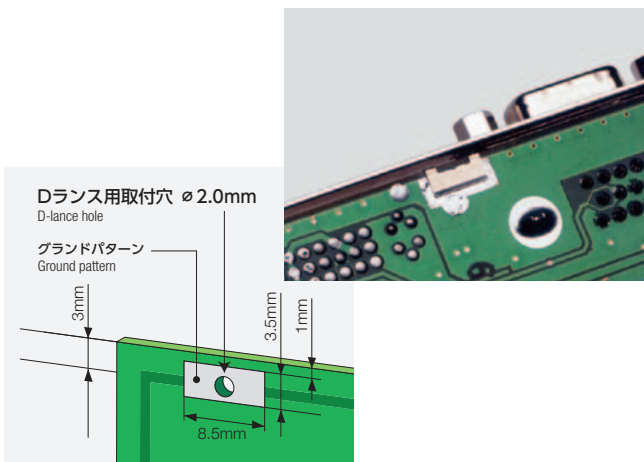
Product Outline and Features

- ▶ クリップ方式採用により省スペース化を実現しました。
- ▶ Dランスの採用により確実な固定が可能です。
- Space saving method by adopting clip.
- The D-lance permits secure fixing.



取付状態

Mounting



仕様

Specifications

形番 Part No.	材質 Materials	板厚 (mm) Thickness	表面処理 Surface Finish	取付板厚 (mm) Plate Thickness
E01JC01E	チタン銅合金 Titanium Copper Alloy	0.1	ニッケルめっき Ni Plating (0.5~1.0 μ m)	1.6

